



Technical Data Sheet

Mini TOP Views LEDs

65-11UWC/S731/TR8

Features

- White SMT package.
- Optical indicator.
- Wide viewing angle.
- Soldering methods: IR reflow soldering.
- Available on tape and reel.
- Pb-free
- The product itself will remain within RoHS compliant version.



Descriptions

- The white LED which was fabricated using a blue LED and a phosphor, and the phosphor is excited by blue light and emits yellow fluorescence. The mixture of blue light and yellow light results in a white emission.

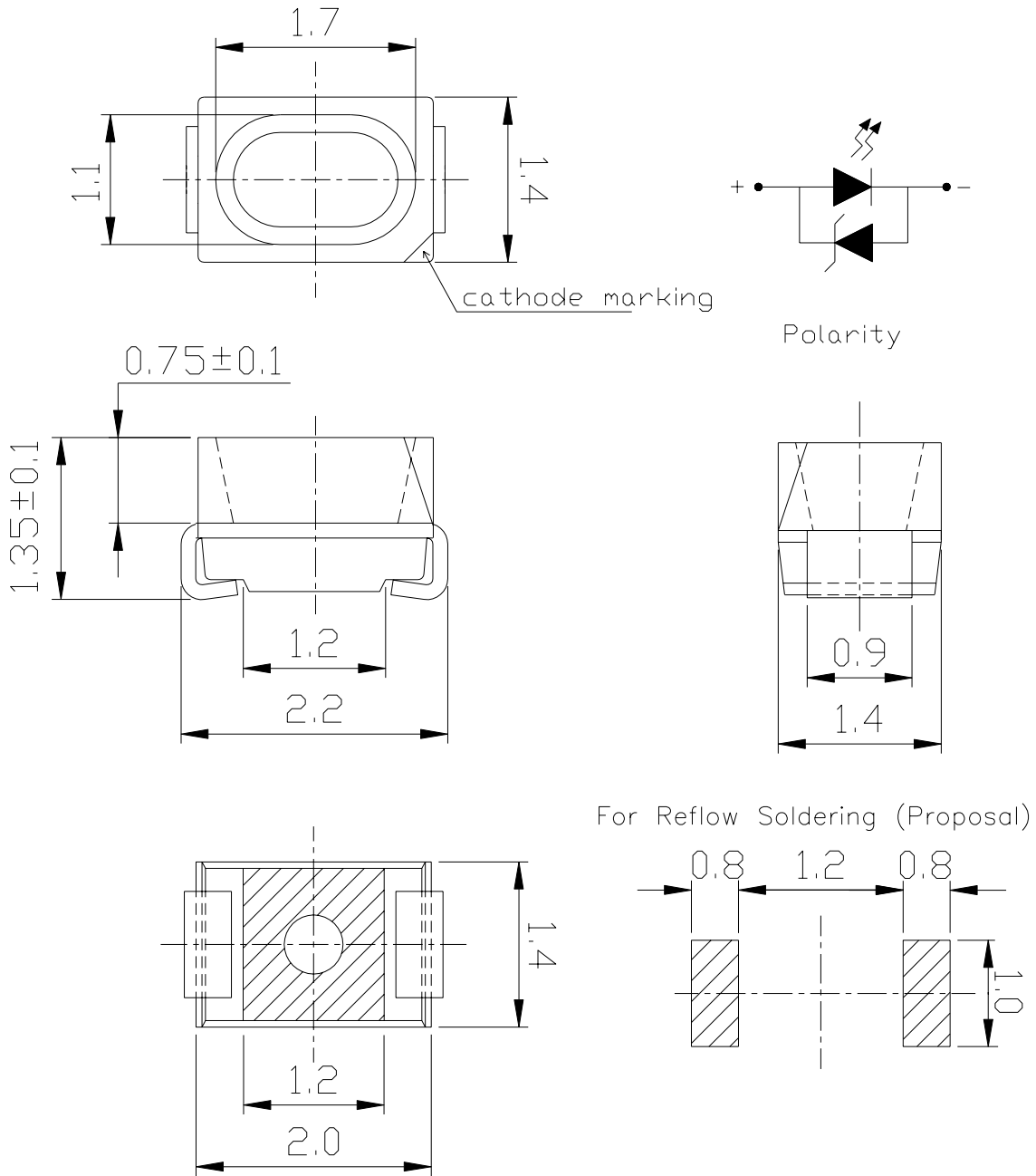
Applications

- Optical indicators.
- Coupling into light guides.
- Backlighting (LCD, cellular phones, switches, keys, displays, illuminated advertising, general lighting).
- Coupling into light guides; Interior automotive lighting (e.g. dashboard backlighting, etc.).

Device Selection Guide

Chip		Lens Color
Material	Emitted Color	
InGaN	White	Water Clear

Package Outline Dimensions



Note: The tolerances unless mentioned is ±0.1mm;Unit = mm

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	25	mA
Operating Temperature	T _{opr}	-40 ~ +100	°C
Storage Temperature	T _{stg}	-40 ~ +105	°C
Electrostatic Discharge(HBM)	ESD	2000	V
Power Dissipation	P _d	110	mW
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	100	mA
Soldering Temperature	T _{sol}	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.	

Notes: The products are sensitive to static electricity and care must be fully taken when handling products.

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Units	Condition
Luminous Intensity	I _v	800	-----	1950	mcd	I _F =20mA
Forward Voltage	V _F	3.00	-----	3.60	V	I _F =20mA
Viewing Angle	2 θ 1/2	--	120	--	deg	I _F =20mA

Notes:

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Forward Voltage ±0.1V



65-11UWC/S731/TR8

Bin Range of Luminous Intensity

Symbol	Bin Code	Min.	Max.	Unit	Condition
Iv	A	800	1000	mcd	IF=20mA
	B	1000	1250		
	C	1250	1560		
	D	1560	1950		

Bin Range Of Forward Voltage

Symbol	Bin	Min	Max	Unit	Condition
VF	37	3.00	3.10	V	IF=20mA
	38	3.10	3.20		
	39	3.20	3.30		
	40	3.30	3.40		
	41	3.40	3.50		
	42	3.50	3.60		

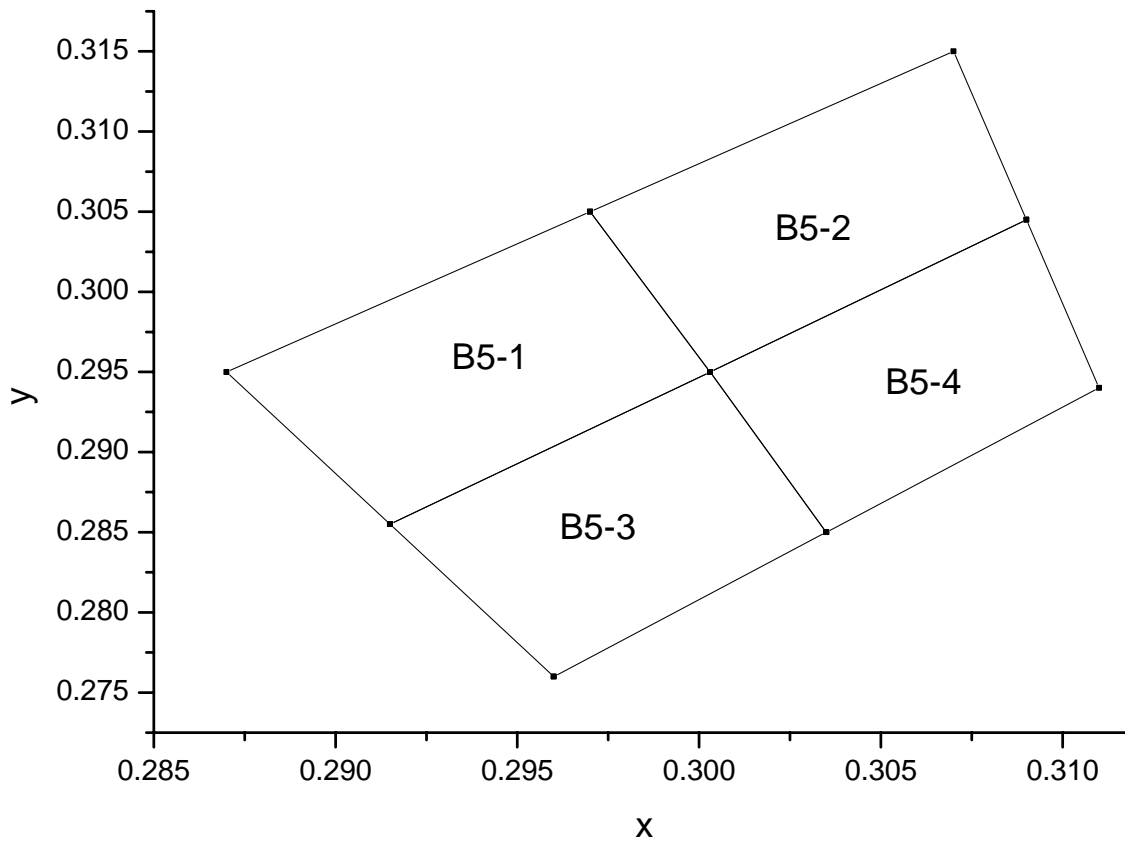
Notes:

- 1.Tolerance of Luminous Intensity $\pm 10\%$
- 2.Tolerance of Forward Voltage $\pm 0.1V$

Chromaticity Coordinates Specifications for Bin Grading

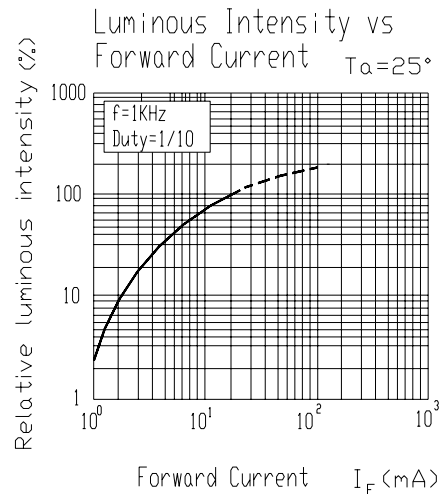
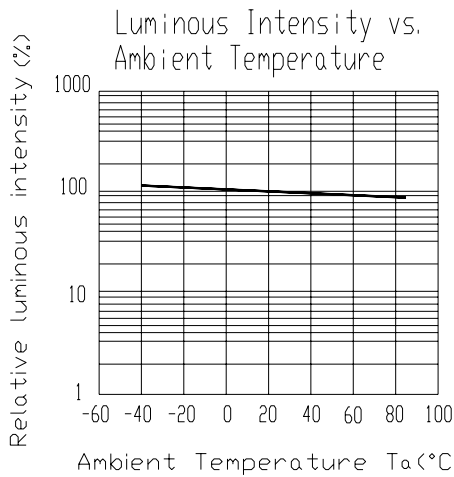
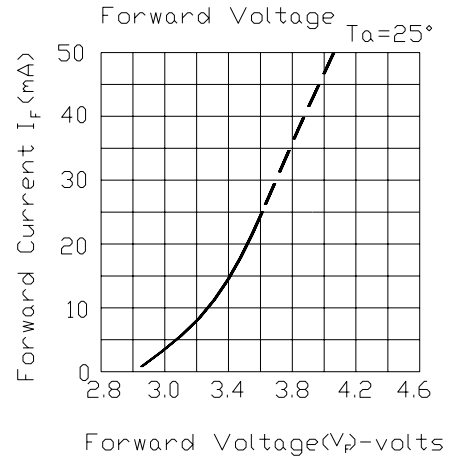
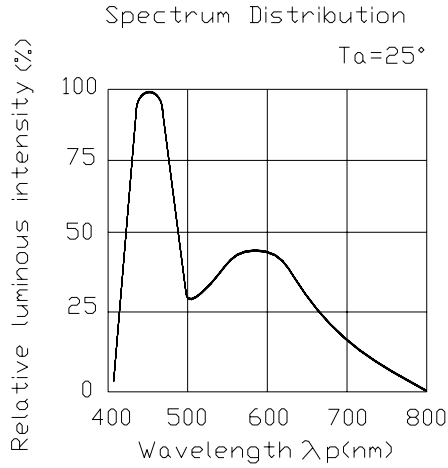
Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
B5-1	0.2915	0.2855	B5-3	0.2960	0.2760
	0.2870	0.2950		0.2915	0.2855
	0.2970	0.3050		0.3003	0.2950
	0.3003	0.2950		0.3035	0.2850
B5-2	0.3003	0.2950	B5-4	0.3035	0.2850
	0.2970	0.3050		0.3003	0.2950
	0.3070	0.3150		0.3090	0.3045
	0.3090	0.3045		0.3110	0.2940

CIE Chromaticity Diagram

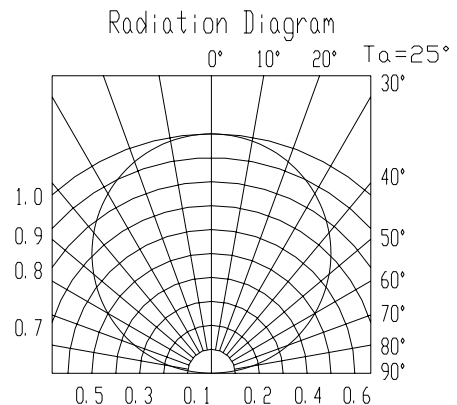
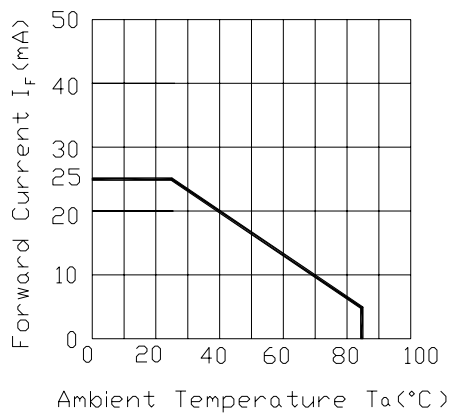


*The C.I.E. 1931 chromaticity diagram (Tolerance ± 0.01).

Typical Electro-Optical Characteristics Curves



Forward Current Derating Curve

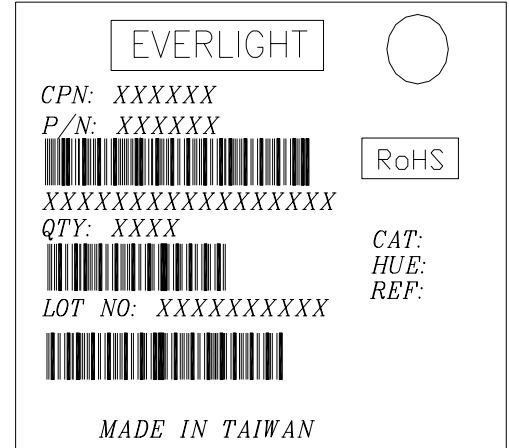


Label explanation

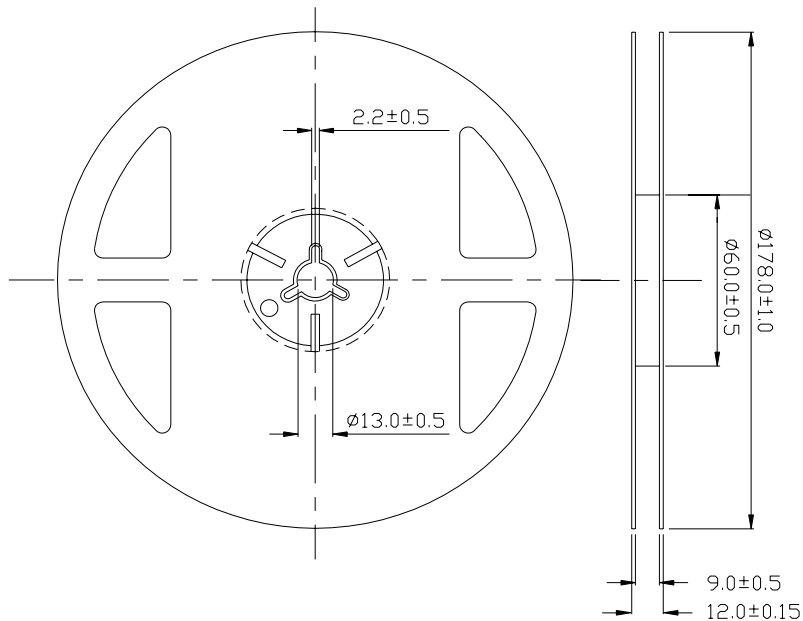
CAT: Luminous Intensity Rank

HUE: Chromaticity Coordinates

REF: Forward Voltage Rank

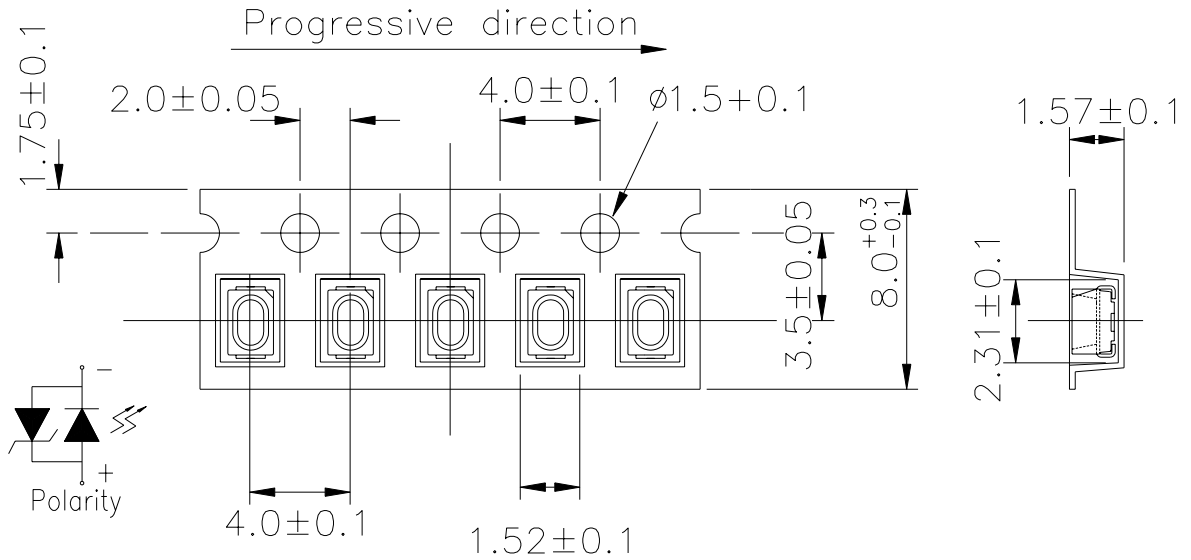


Reel Dimensions



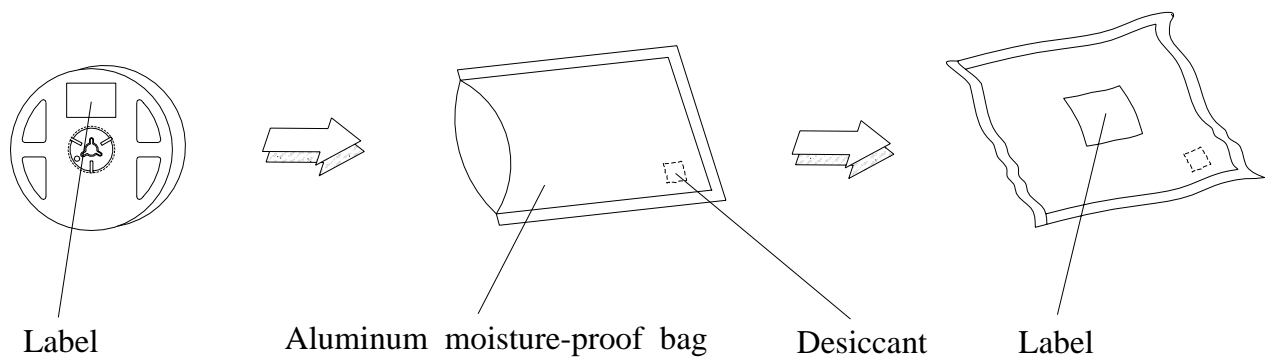
Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit = mm

Carrier Tape Dimensions: Loaded quantity per reel 2000 PCS/reel



Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$,Unit = mm

Moisture Resistant Packaging



65-11UWC/S731/TR8
Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C ±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ∫ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100°C 5min ∫ 10 sec L : -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	I _F = 20 mA / 25°C	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less.

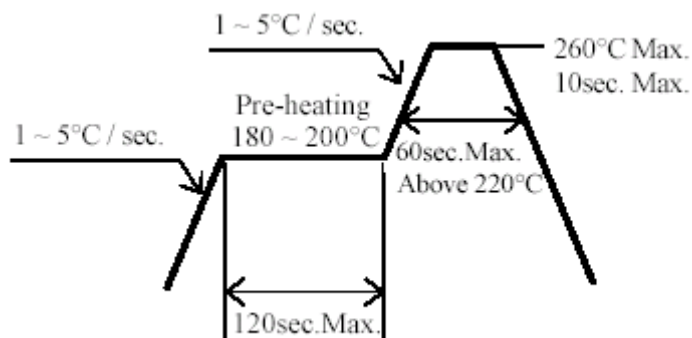
If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

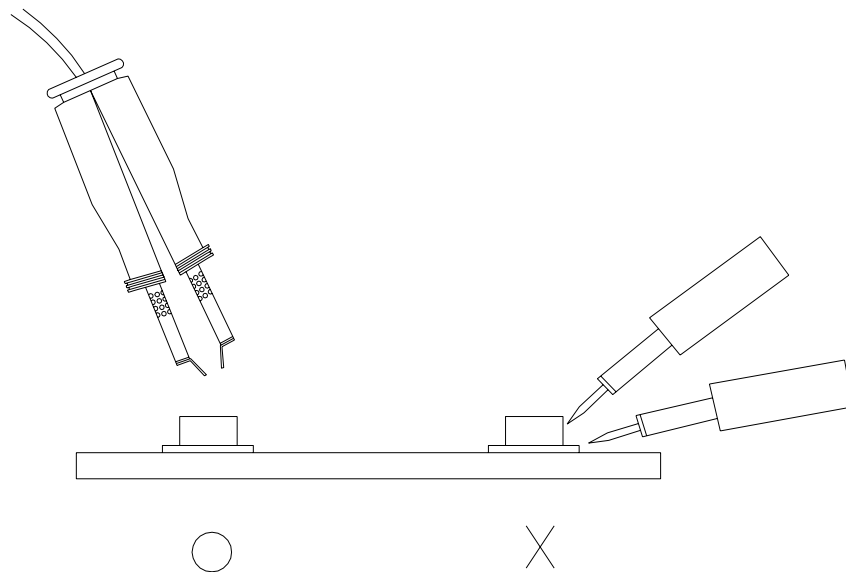
3.4 After soldering, do not warp the circuit board.

65-11UWC/S731/TR8**4.Soldering Iron**

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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